L Number	Hits	Search Text	DB	Time t
1	4	(("5751553") or ("4538124") or ("5602720") or	USPAT;	Time stamp
		("5774342")).PN.	EPO	2004/10/15 11:25
=	1071	428/210.ccls.	USPAT;	00044404444
				2004/10/14 16:36
_	160	428/210.ccls. and (((circuit or wiring) adj (board or layer or	EPO	000444544
		substrate)) with ceramic)	USPAT;	2004/10/14 17:26
_	4473	(((circuit or wiring) adj (board or layer or substrate)) same	EPO	
		(heat adj sink))	USPAT;	2004/10/14 17:27
_	385	(((circuit or wiring) adj (board or layer or substrate)) same	EPO	
		ceramic same (heat adj sink))	USPAT;	2004/10/14 18:39
-	177	((((circuit or wiring) adj (board or layer or substrate)) same	EPO	
		ceramic same (heat adj sink))) and (recess\$3 or cavity or	USPAT;	2004/10/14 17:45
		indent\$5)	EPO	
_	9		1.	
	ĺ	((((circuit or wiring) adj (board or layer or substrate)) same	USPAT;	2004/10/14 17:52
		ceramic same (heat adj sink))) and ((recess\$3 or cavity or depress\$3 or indent\$5) near3 base)	EPO	İ
-	3	(///circuit or wiring) adi /hanna an lare		
		((((circuit or wiring) adj (board or layer or substrate)) same	USPAT;	2004/10/14 17:52
		ceramic same (heat adj sink))) and ((recess\$3 or cavity or	EPO	
_ 1	1	depress\$3 or indent\$5) with portion with base)	İ	
	'	(metal\$3 with base with carrier with ((cavity or recess\$3 or	USPAT;	2004/10/14 17:56
_	70	depress\$3) adj portion))	EPO	
ļ	70	(prevent with (bending or flexing)) and (ceramic with ((wiring	USPAT;	2004/10/14 18:08
_ [0	or circuit) adj (board or substrate or layer)))	EPO	
ĺ	١	(ceramic with ((wiring or circuit) adj (board or substrate or	USPAT;	2004/10/14 18:13
ľ	ļ	layer)) same (reside\$2 with within with (cavity or recess\$3 or	EPO	
_	0	depress\$3)))		
	0	(ceramic with ((wiring or circuit) adj (board or substrate or	USPAT;	2004/10/14 18:13
		layer)) same (reside\$2 with (cavity or recess\$3 or	EPO	
_	4	depress\$3)))	†	
	1	(metallic near3 base near3 carrier) same (recess\$3 or	USPAT;	2004/10/14 18:16
	70	depress\$3 or cavity)	EPO	
-	79	(metallic near3 base) same ((recess\$3 or depress\$3 or	USPAT;	2004/10/14 18:16
	424	cavity) near3 portion)	EPO	
-	134	(metallic near3 (base or substrate)) same ((recess\$3 or	USPAT;	2004/10/14 18:16
[_	depress\$3 or cavity) near3 portion)	EPO	10, 11 10. 10
· 1	5	("4246595" "4672417" "4692791" "4724472"	USPAT	2004/10/14 18:28
ł	0000	"4866501").PN.		200 1/10/14 10:20
	2360	(((circuit or wiring) adj (board or layer or substrate)) with	USPAT;	2004/10/14 18:55
}		(align\$4 near4 (hole or aperture)))	EPO '	1 10,00
·	.0	((((circuit or wiring) adj (board or layer or substrate)) with	USPAT;	2004/10/14 18:42
		(align\$4 near4 (hole or aperture)))) and (base with (note	EPO	2001/10/14 10:42
1		near3 (perpendicular or vertical)))		1
1	5	((((circuit or wiring) adj (board or layer or substrate)) with	USPAT;	2004/10/14 18:42
		(align\$4 near4 (hole or aperture)))) and (pole near3	EPO	2007/10/14 10:42
!	1	(perpendicular or vertical))		
	107	((((circuit or wiring) adj (board or layer or substrate)) with	USPAT;	2004/10/14 18:44
	,	(align\$4 near4 (hole or aperture)))) and (ceramic adi	EPO	2004/10/14 10:44
Ī		(substrate or layer or board))		
Ì	52	((circuit or wiring) adj (board or layer or substrate)) with	USPAT;	2004/10/14 10:57
		(alignment with (hole or aperture) with (alignment adj post))	EPO EPO	2004/10/14 18:57